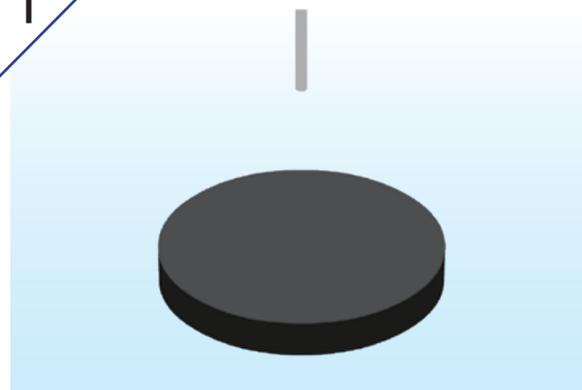
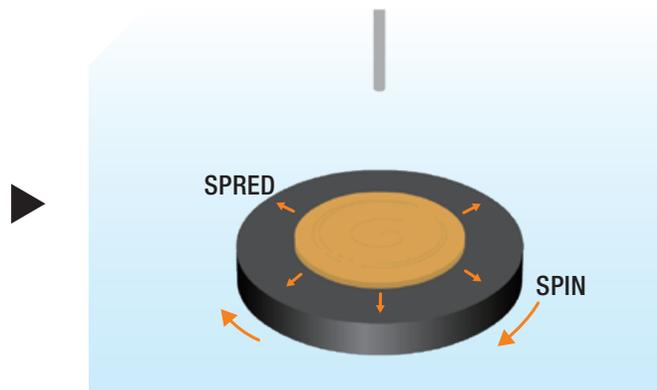


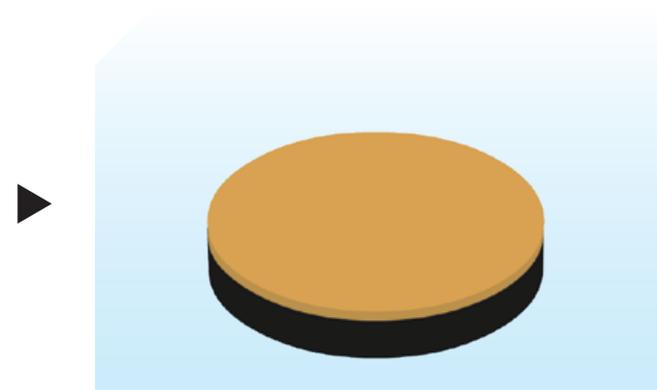
1 旋涂



晶圆安置在旋涂盘上

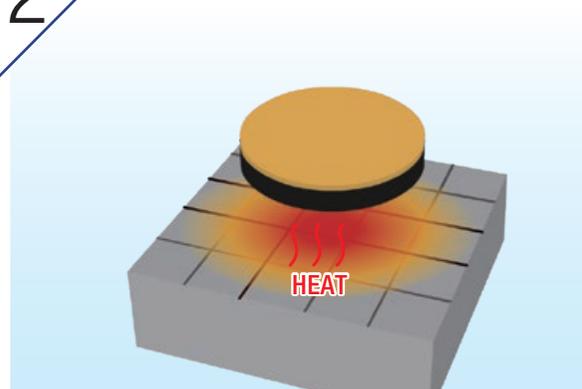


通过旋涂将液体蜡涂布在晶圆表面



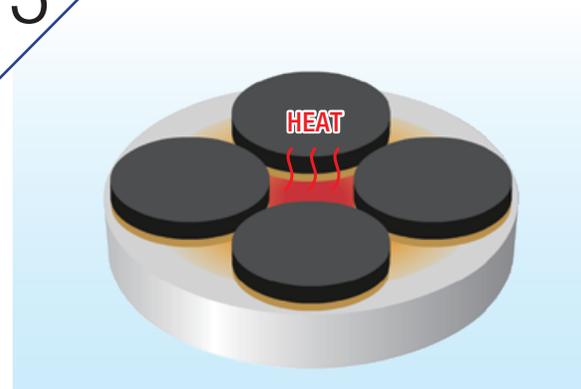
涂布的液态蜡均匀成膜

2 烘烤



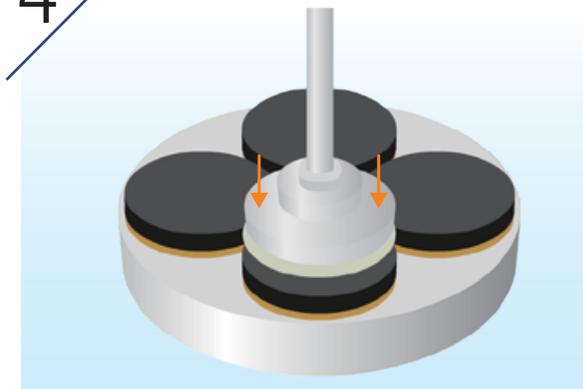
加热使液态蜡溶媒挥发,固态分软化

3 贴片



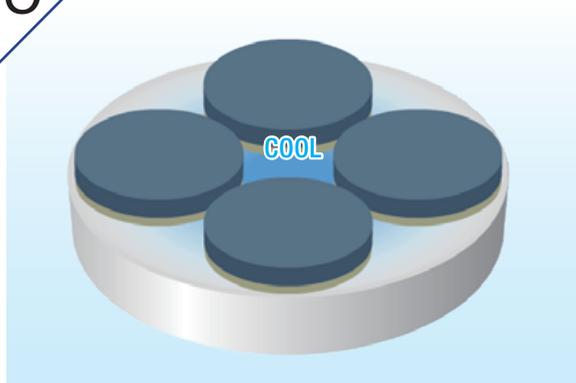
烘烤后的晶圆贴附在载盘上

4 加压



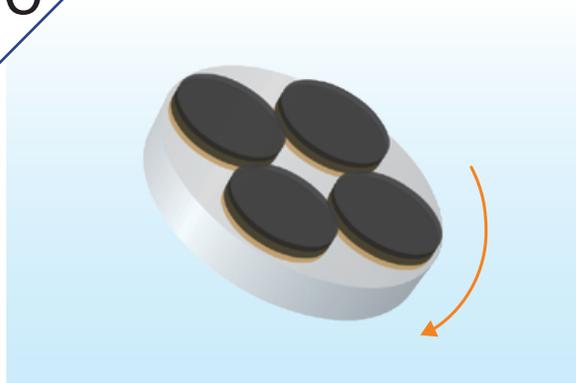
通过载盘对晶圆均匀加压贴片

5 冷却

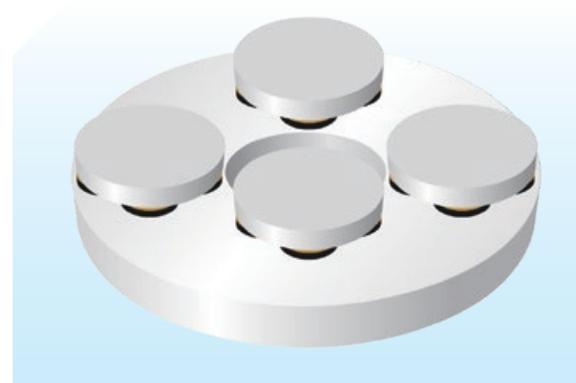


冷却贴附完成的工件和载盘

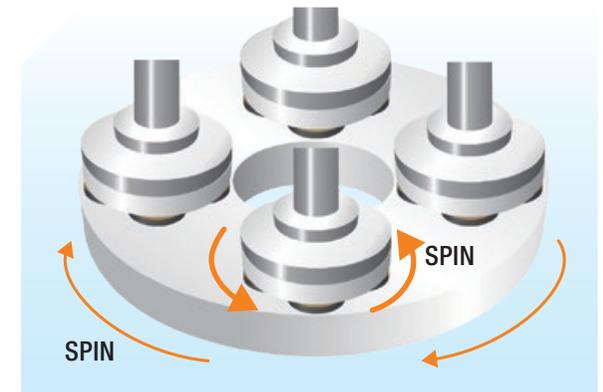
6 抛光



将贴附晶圆的载盘翻转

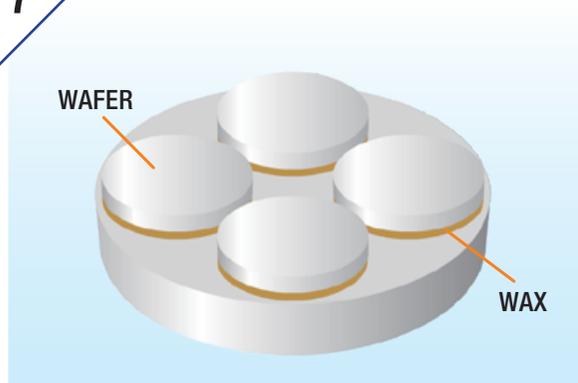


安置在研磨装置

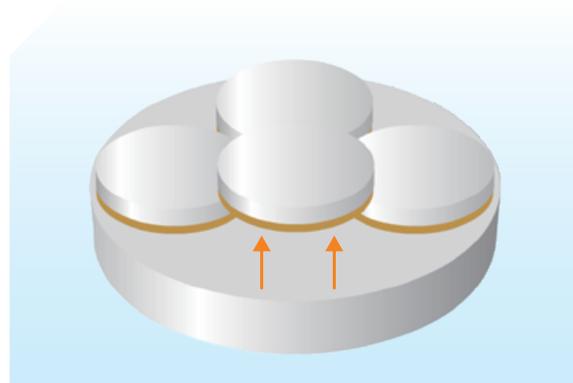


抛光加工中

7 分离



抛光工艺和喷淋工艺结束

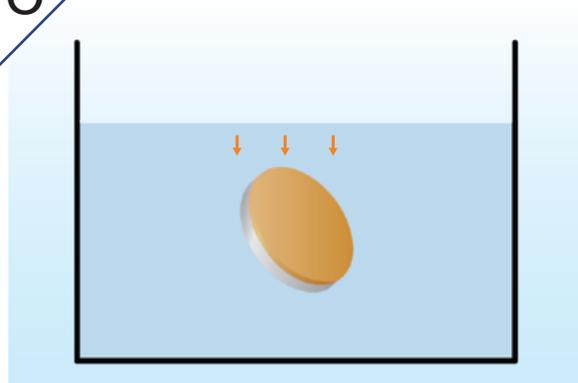


晶圆从载盘上剥离

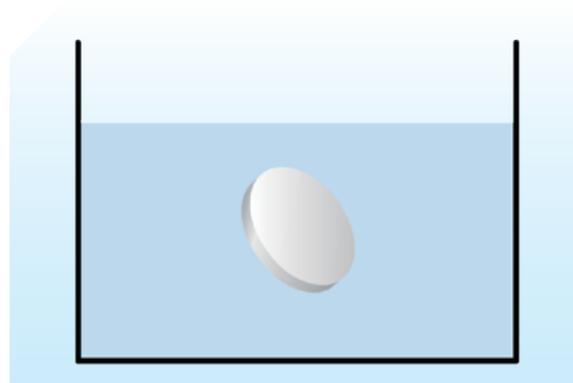


晶圆背面有蜡残留

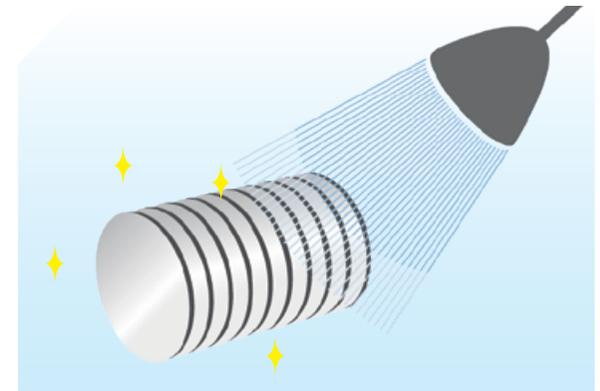
8 清洗



清洗剂浸泡晶圆



蜡清洗完成



使用纯水进行清洗冲淋